# **MOSFET** – N-Channel, POWERTRENCH®

150 V, 169 A, 6.3 m $\Omega$ 

#### **Features**

- Typ  $r_{DS(on)} = 5 \text{ m}\Omega$  at  $V_{GS} = 10 \text{ V}$ ,  $I_D = 80 \text{ A}$
- Typ  $Q_{g(tot)} = 70 \text{ nC}$  at  $V_{GS} = 10 \text{ V}$ ,  $I_D = 80 \text{ A}$
- UIS Capability
- This Device is Pb-Free and is RoHS Compliant

#### **Applications**

- Industrial Motor Drive
- Industrial Power Supply
- Industrial Automation
- Battery Operated tools
- Battery Protection
- Solar Inverters
- UPS and Energy Inverters
- Energy Storage
- Load Switch

## MAXIMUM RATINGS (T<sub>J</sub> = 25°C, unless otherwise specified)

Symbol	Parameter	Ratings	Unit
VDSS	Drain to Source Voltage	150	V
VGS	Gate to Source Voltage	±20	V
I <sub>D</sub>	Drain Current – Continuous ( $V_{GS} = 10 \text{ V}$ ) (Note 1) $T_C = 25^{\circ}\text{C}$	169	Α
	Pulsed Drain Current $T_C = 25^{\circ}C$	See Figure 4	
EAS	Single Pulse Avalanche Energy (Note 2)	502	mJ
P <sub>D</sub>	Power Dissipation	500	W
	Derate above 25°C	3.3	W/°C
$T_J$ , $T_{STG}$	Operating and Storage Temperature	-55 to +175	°C
$R_{\theta JC}$	Thermal Resistance Junction to Case	0.3	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance Junction to Ambient (Note 3)	43	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

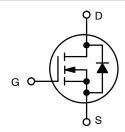
- Current is limited by junction temperature.
   Starting T<sub>J</sub> = 25°C, L = 0.24 mH, I<sub>AS</sub> = 64 A, V<sub>DD</sub> = 100 V during inductor charging and V<sub>DD</sub> = 0 V during in avalanche.
- 3.  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta JA}$ is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2 oz copper.



#### ON Semiconductor®

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V <sub>DSS</sub>	r <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
150 V	6.3 mΩ @ 10 V	169 A

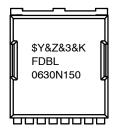


MOSFET - N-Channel



H-PSOF8L 11.68x9.80 CASE 100CU

#### MARKING DIAGRAM



\$Y = ON Semiconductor Logo &Z = Assembly Plant Code

&3 = Date Code

= Lot Run Traceability Code FDBL0630N150 = Specific Device Code

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 6 of this data sheet.

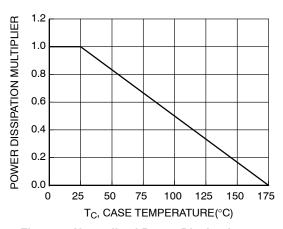
# **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Condition		Min	Тур	Max	Unit
OFF CHAF	RACTERISTICS				•		
B <sub>VDSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$		150	_	-	V
I <sub>DSS</sub>	Drain to Source Leakage Current	V <sub>DS</sub> = 150 V, V <sub>GS</sub> = 0 V	$T_J = 25^{\circ}C$	-	-	1	μΑ
			T <sub>J</sub> = 175°C (Note 4)	-	-	1	mA
I <sub>GSS</sub>	Gate to Source Leakage Current	V <sub>GS</sub> = ±20 V		-	-	±100	nA
ON CHAR	ACTERISTICS			•			•
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$		2.0	2.8	4.0	V
r <sub>DS(on)</sub>	Drain to Source On Resistance	I <sub>D</sub> = 80 A, V <sub>GS</sub> = 10 V	$T_J = 25^{\circ}C$	-	5	6.3	mΩ
			$T_J = 175^{\circ}C$ (Note 4)	_	14	17.5	mΩ
DYNAMIC	CHARACTERISTICS	•		1	•	•	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 75V, V <sub>GS</sub> = 0V, f =	= 1 MHz	-	5805	-	pF
C <sub>oss</sub>	Output Capacitance			_	536	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1		_	16	-	pF
R <sub>g</sub>	Gate Resistance	f = 1 MHz		-	2.2	_	Ω
Q <sub>g(ToT)</sub>	Total Gate Charge at 10 V	V <sub>GS</sub> = 0 to 10 V, V <sub>DD</sub> = 75 V, I <sub>D</sub> = 80 A		-	70	90	nC
Q <sub>g(th)</sub>	Threshold Gate Charge	V <sub>GS</sub> = 0 to 2 V, V <sub>DD</sub> = 75 V, I <sub>D</sub> = 80 A		-	10.5	13	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	V <sub>DD</sub> = 75 V, I <sub>D</sub> = 80 A		-	32.5	=	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	V <sub>DD</sub> = 75 V, I <sub>D</sub> = 80 A		-	10	-	nC
SWITCHIN	G CHARACTERISTICS						-
t <sub>on</sub>	Turn-On Time	$V_{DD} = 75 \text{ V}, I_D = 80 \text{ A}, V_{DD} = 75 \text{ V}$	$'_{\rm GS}$ = 10 V, $R_{\rm GEN}$ = 6 $\Omega$	-	_	80	ns
t <sub>d(on)</sub>	Turn-On Delay Time	]		-	39	_	ns
t <sub>r</sub>	Rise Time			-	30	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	]		-	70	-	ns
t <sub>f</sub>	Fall Time	1		-	23	-	ns
t <sub>off</sub>	Turn-Off Time	<u> </u>		-	-	130	ns
DRAIN-SC	OURCE DIODE CHARACTERISTICS						
$V_{SD}$	Source to Drain Diode Voltage	I <sub>SD</sub> = 80 A, V <sub>GS</sub> = 0 V		-	-	1.25	V
		I <sub>SD</sub> = 40 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
T <sub>rr</sub>	Reverse Recovery Time	$I_F = 80 \text{ A}, dI_{SD}/dt = 100$	A/μs, V <sub>DD</sub> = 120 V	_	108	125	ns
Q <sub>rr</sub>	Reverse Recovery Charge	1		_	323	467	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. The maximum value is specified by design at T<sub>J</sub> = 175°C. Product is not tested to this condition in production.

#### **TYPICAL CHARACTERISTICS**



200 (¥) 160 120 80 25 50 75 100 125 150 175 200 T<sub>C</sub>, CASE TEMPERATURE(°C)

Figure 1. Normalized Power Dissipation vs.

Case Temperature

Figure 2. Maximum Continuous Drain Current vs.

Case Temperature

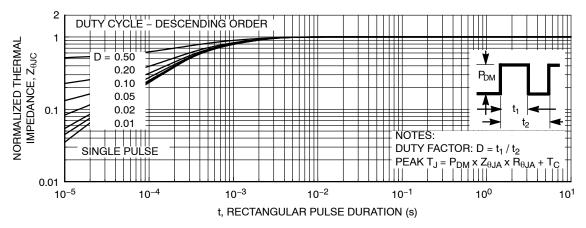


Figure 3. Normalized Maximum Transient Thermal Impedance

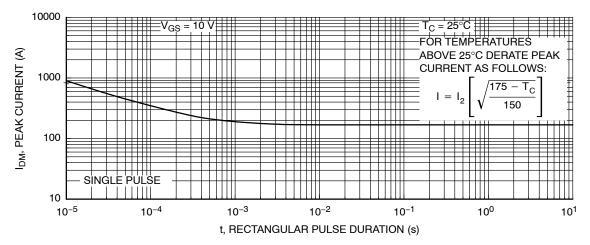


Figure 4. Peak Current Capability

#### TYPICAL CHARACTERISTICS (continued)

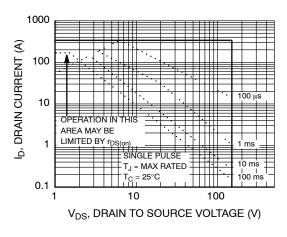
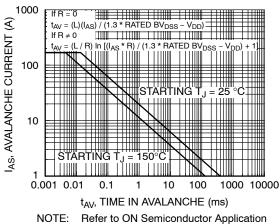


Figure 5. Forward Bias Safe Operating Area



Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching Capability

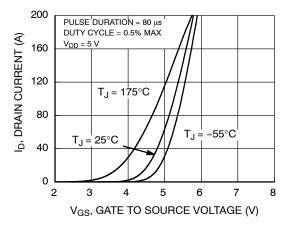


Figure 7. Transfer Characteristics

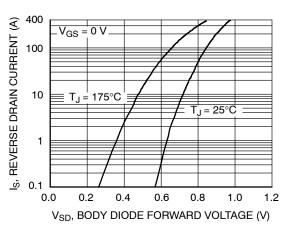


Figure 8. Forward Diode Characteristics

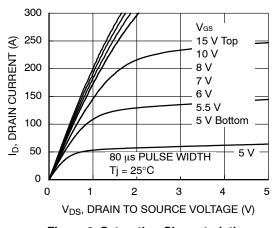


Figure 9. Saturation Characteristics

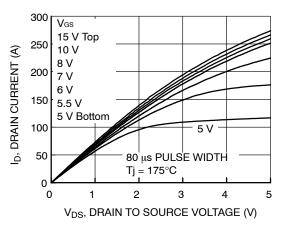


Figure 10. Saturation Characteristics

#### TYPICAL CHARACTERISTICS (continued)

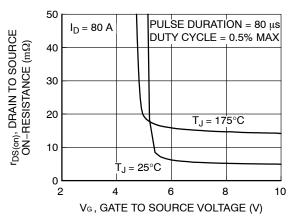


Figure 11. Rdson vs. Gate Voltage

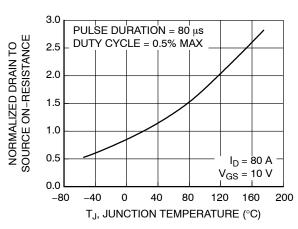


Figure 12. Normalized Rdson vs. Junction Temperature

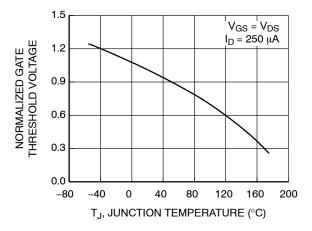


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

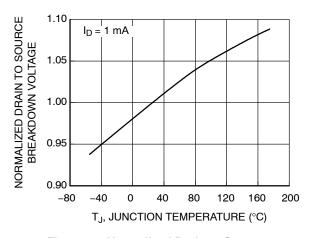


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

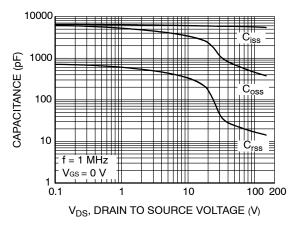


Figure 15. Capacitance vs Drain to Source Voltage

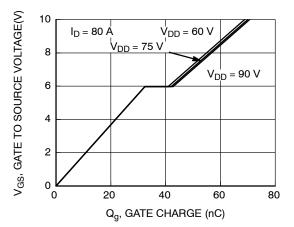


Figure 16. Gate Charge vs Gate to Source Voltage

## **ORDERING INFORMATION**

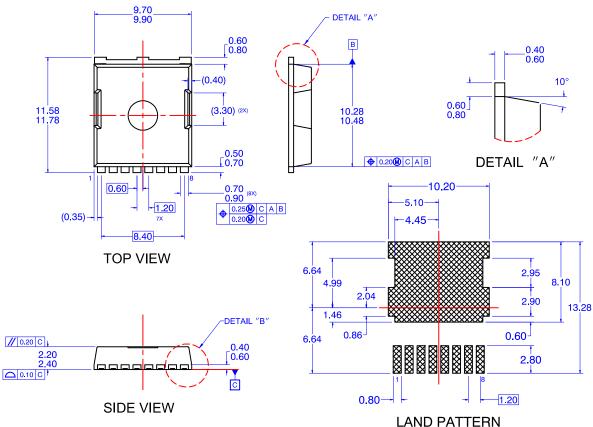
Device	Device Marking	Package	Shipping <sup>†</sup>
FDBL0630N150	FDBL0630N150	H-PSOF8L 11.68x9.80 (Pb-Free)	2000 / Tape & Reel

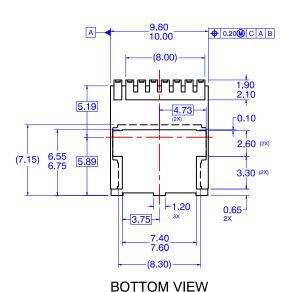
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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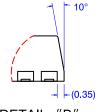
#### H-PSOF8L 11.68x9.80 CASE 100CU ISSUE O

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RECOMMENDATION



DETAIL "B"

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